

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2842740

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
XIAOFENG BI	05/04/2014
RECEIVING PARTY DATA	
Name:	DONGGUAN KINGSUN OPTOELECTRONIC CO., LTD
Street Address:	HENGJIANGXIA VILLAGE, CHANGPING TOWN
City:	DONGGUAN, GUANGDONG
State/Country:	CHINA
Postal Code:	523565
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13989818
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	SCH-1308-USPT
NAME OF SUBMITTER:	CHARLES S. HO
SIGNATURE:	/charles ho/
DATE SIGNED:	05/06/2014
Total Attachments: 1	
source=Assignment_SCH-1308-USPT (00235380)#page1.tif	

ASSIGNMENT - Patent Application

Docket Number: **SCH-1308-USPT**

Whereas, the Assignor, comprising the following named inventors:

ASSIGNOR(s)/
INVENTOR(s)

Xiaofeng Bi

made an invention entitled: **PROCESS FOR MAKING A HEAT RADIATING STRUCTURE FOR HIGH-POWER LED**

for which an application for Letters Patent of the United States:
(Select one of the following):

- is executed concurrently herewith
 was filed in the U.S. Patent and Trademark Office on May 28, 2013,
as U.S. Patent Application Serial No.: 13/989,818

ASSIGNEE
(Full Name, Address and
Country)

Dongguan Kingsun Optoelectronic Co., Ltd
Hengjiangxia Village, Changping Town, Dongguan, Guangdong 523565
China

is desirous of acquiring our entire right, title and interest in and to said invention and the Letters Patent to be obtained therefor,

Now, therefore, in consideration of the payment by Assignee to Assignor of a sum corresponding to One Dollar (\$1.00), and for other good and valuable consideration, the receipt of which is hereby acknowledged, Assignor, intending to be legally bound, hereby sells, assigns and transfers to Assignee, its successors and assigns, the full and exclusive right, title and interest in and to said invention, all applications for Letters Patent for said invention, including all divisions, continuations, and continuations-in-part thereof, all rights to claim priority based thereon, and all Letters Patent, including reissues, to be obtained therefor, including any and all foreign patent rights in this invention corresponding thereto.

Assignor hereby warrants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor agrees it shall be legally bound, upon request of the Assignee or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the Assignor has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the Assignee, and to execute all instruments proper to carry out the intent of this instrument.

In witness whereof, this Assignment is executed on the day indicated below.

	Typed or Printed Name	Signature	Date
SIGNATURE	Xiaofeng Bi	X <i>Xiaofeng Bi</i>	X <i>May 4, 2014</i>
	Jia Yuan	X <i>Jia Yuan</i>	X <i>May 4, 2014</i>
	* Witness to Assignor	* Witness to Assignor	